

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	METHOD OF FORMING A HIGHLY THERMALLY CONDUCTIVE AND HIGH STRENGTH ARTICLE
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Application Number: 10/605059
 Confirmation Number: 2058
 First Named Applicant: Kevin McCULLOUGH
 Attorney Docket Number: C001P00472US2
 Art Unit: 1714



Search string: (3398233 or 3673121 or 3708387 or 4098945
 or 4307147 or 4367745 or 4496475 or 4568592
 or 4664971 or 4689250 or 4816184 or 5011870
 or 5011872 or 5021494 or 5098610 or 5098611
 or 5106540 or 5171774 or 5180513 or 5183594
 or 5213715 or 5225110 or 5286416 or 5302456
 or 5334330 or 5373046 or 5397608 or 5445308
 or 5490319 or 5522962 or 5536568 or 5580493
 or 5669381 or 5681883 or 5770305 or 5834337
 or 5851644 or 5863467 or 5945217 or 6048919
 or 6251978 or 6251978 or 6303096 or 5037590
 or 5552214 or 20020025998 or
 20020022686),pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
<input checked="" type="checkbox"/>	1	3398233	1968-08-20	Lizasoain et al.			
<input type="checkbox"/>	2	3673121	1972-06-27	Meyer		252	511
<input type="checkbox"/>	3	3708387	1973-01-02	Turner et al			
<input type="checkbox"/>	4	4098945	1978-07-04	Oehmke		428	327
<input type="checkbox"/>	5	4307147	1981-12-22	Ohishi et al.		428	268
<input type="checkbox"/>	6	4367745	1983-01-11	Welage		128	303.13
<input type="checkbox"/>	7	4496475	1985-01-29	Abrams		252	514
<input type="checkbox"/>	8	4568592	1986-02-04	Kawaguchi et al.		428	107
<input checked="" type="checkbox"/>	9	4664971	1987-05-12	Soens		428	288
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10	4689250	1987-08-25	Quella et al.	427	216
11	4816184	1989-03-28	Fukuda et al.	252	511
12	5011870	1991-04-30	Peterson	523	220
13	5011872	1991-04-30	Latham et al.	523	440
14	5021494	1991-06-04	Toya	524	404
15	5098610	1992-03-24	Okamura et al.	252	511
16	5098611	1992-03-24	Honda et al.	252	518
17	5106540	1992-04-21	Barma et al.	252	511
18	5171774	1992-12-15	Ueno et al.	524	495
19	5180513	1993-01-19	Durand	252	62.55
20	5183594	1993-02-02	Yoshinaka et al.	252	518
21	5213715	1993-05-25	Patterson et al.	252	518
22	5225110	1993-07-06	Kathirgamanathan	252	512
23	5286416	1994-02-15	Teichmann et al.	252	512
24	5302456	1994-04-12	Matsui	428	407
25	5334330	1994-08-02	Rowlette	252	512
26	5373046	1994-12-13	Okamura et al.	524	413
27	5397608	1995-03-14	Soens	428	34.5
28	5445308	1995-08-29	Nelson et al.	228	121
29	5490319	1996-02-13	Nakamura et al.	29	596
30	5522962	1996-06-04	Koskenmaki et al.	156	272.4
31	5536568	1996-07-16	Teruo	428	327
32	5580493	1996-12-03	Chu et al.	252	511
33	5669381	1997-09-23	Hyatt	428	402
34	5681883	1997-10-28	Hill et al.	524	404
35	5770305	1998-06-23	Terasaka	428	328
36	5834337	1998-11-10	Unger et al.	438	122
37	5851644	1998-12-22	McArdle et al.	428	213
38	5863467	1999-01-26	Mariner et al.	252	511
39	5945217	1999-08-31	Hanrahan	428	389
40	6048919	2000-04-11	McCullough	524	404
41	6251978	2001-06-26	McCullough	524	404
42	6251978	2001-06-26	McCullough	524	404
43	6303096	2001-10-16	Yamamoto et al.	B1	423
44	5037590	1991-08-06	Fukushima	264	29.2
45	5552214	1996-09-03	Kobomura et al.	428	294

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
3	1	20020025998	2002-02-28	McCullough	A1	524	66
13	2	20020022686	2002-02-21	Itoh et al.	A1	524	504

Signature

Examiner Name	Date
Tae Yoon	2-26-04